

TOP STAR

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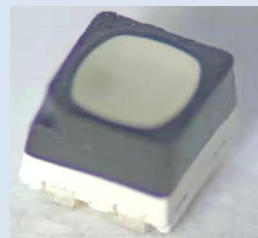
EXPLORATION · ENDLESS

规格书 SPECIFICATION

客户名称 Customer Name	
产品型号 Product Type	RS-E1415RGB-CCN (Top-star 1415 铜支架)
产品描述 Product Description	1415 户外全彩 SMD LED



客户确认 Customer Confirm			瑞晟光电研发中心 R&D Center		
核准 Confirm	审核 Approve	确认 Check	核准 Confirm	审核 Approve	制作 Draw
版次/Version NO: B		发行日期/Release Date: 2023年04月15日			

产品型号/Product Type :**RS-E1415RGB-CCN****产品简介/Product introduction:**

本产品属于户外表面贴装全彩器件，采用外黑内白设计，高对比度，哑光封装，无镜面反射。拥有多重防水功能，高可靠性、长寿命、宽视角等特点，是全户外显示装饰领域的理想选择。

These products are Outdoor full-color SMD components with black frame and white refractor, high contrast, matt packaging and non-mirror reflection, which are featured by multiple waterproof performance, good reliability, long lifespan and wide viewing angle. They are designed for outdoor display and decoration applications.

产品特点/Product Features:

◇ 发光颜色: RGB 三色

Emitting color: RGB Full-color

◇ 芯片材质: R:AlGaInP/G:GaN/B: InGaN

Chip material : R:AlGaInP/G: InGaN/B: InGaN

◇ 1.6×1.54×1.6 mm 表面贴片发光二极管

1.6×1.54×1.6 mm TOP LED

◇ 视角度: 110°

View Angle:110°

◇ 封装材料: 环氧树脂

Encapsulation: Epoxy Resin

◇ 焊接方法: 有铅&无铅 回流焊

Soldering methods: Pb&Pb-Free reflow soldering

◇ 光强度高, 功耗低, 可靠性好, 寿命长, 高对比度

High Luminous Intensity ,Low Power Dissipation, good Reliability and Long Life

产品应用/ Applications:

◇ 户外显示屏

Outdoor Full-color Video Screen

◇ 室内照明和室外照明

Indoor lighting and outdoor lighting

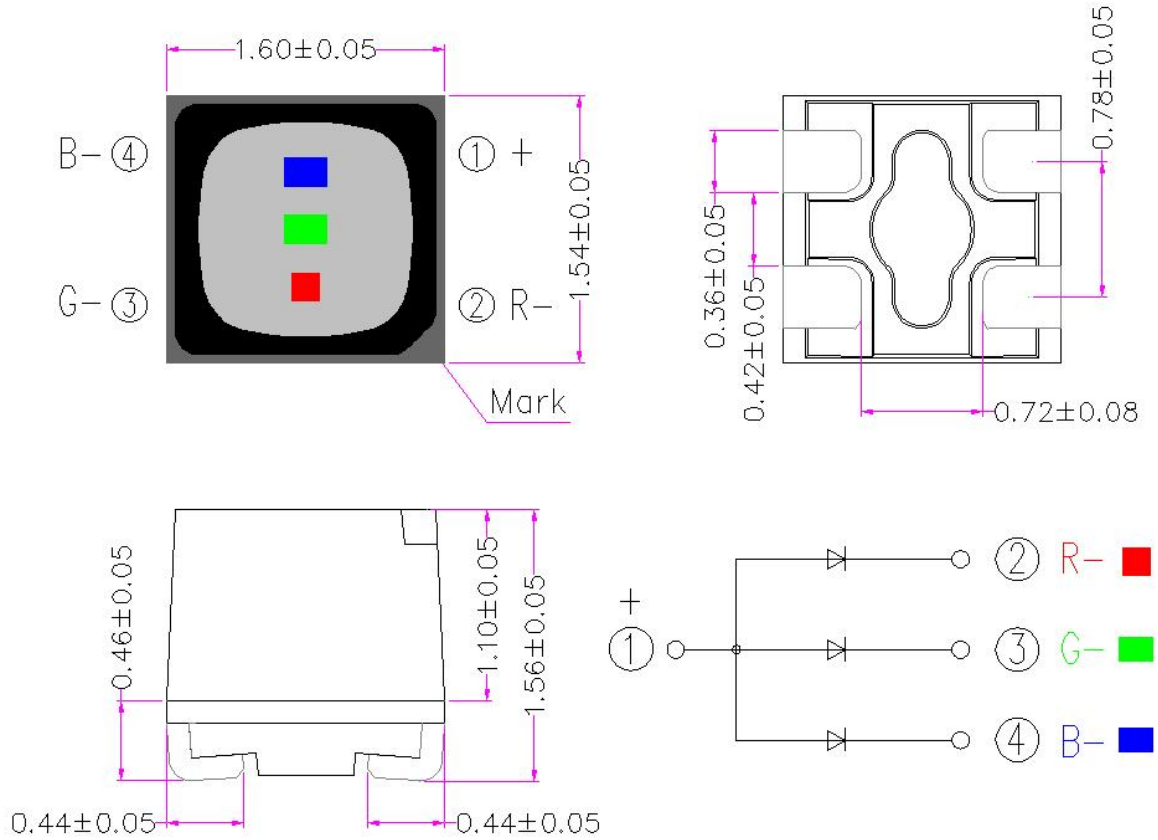
◇ 液晶背光源

Liquid crystal backlight

◇ 装饰照明

Decorative Lighting

产品规格/Product Specification Drawing :



注意/NOTE:

1. 所有尺寸单位为 mm

All dimensions in mm

2. 如无特殊说明公差范围为 ± 0.1 mm

The tolerance range is ± 0.1 mm unless otherwise specified.

3. 在数据表中描述的技术参数如有变更，恕不另行通知。

The technical parameters described in Spec. are subject to change without notice.

4. 此半导体器件为静电敏感元件,请戴静电防护用具拿取,所有机台设备请做好接地处理。

This product is an electrostatic sensitive element, please wear electrostatic protective equipment to take it, and all machine equipment shall be grounded properly.

主要的光电特性参数表 (TA=25°C) / Electrical/Optical Characteristics (TA=25°C)

发光色 Color	波长 (nm) Dominant Wavelength			发光强度 (mcd) Luminous Intensity (mcd)			反向 电流 I _R (uA) Reverse Current (uA)	测试 条件 Test Condition	发光 角度 View Angel	正向电 压 Forward Voltage (v)
	最小值 Min.	典型值 Typ.	最大值 Max.	最小值 Min.	典型值 Typ.	最大值 Max.	V _R = 9V			
Red	618	622	625	300	420	550	0.2	I _F = 15mA	110	1.8-2.4
Green	522	528	532	450	700	800	0.2	I _F = 8mA	110	2.8-3.4
Blue	462	468	472	60	85	120	0.2	I _F = 5mA	110	2.8-3.4

最大限度规格 (TA=25°C) / Absolute Maximum Ratings (TA=25°C)

项目 Parameter	符号 Symbol	最大限度规格 Maximum Ratings			单位 Unit
		R	G	B	
正向电流/ Forward Current	I _F	25	25	20	mA
峰值正向电流/ Peak Forward current	IFP	50	50	50	mA
反向电压/ Reverse voltage	V _R	10	10	10	V
消耗功率/power dissipation	P _D	60	80	64	mW
工作温度/ working temperature	Topr	-40 ~ +85			°C
贮存温度/ Storage temperature	Tstg	-40 ~ +100			°C
回流焊温度/ Reflow temperature	Tsol	Max. 255°C for 10sec Max.			

注意事项/Note:

1) 产品光电性能等级由我司自行决定, 各不同等级的产品光电性能有所差异, 请客户根据己方使用条件自行决定使用方法。

The parameters above only for your reference. In case of any discrepancy, please adhere to the label of our actual products.

2) 发光强度的测量公差为: ±10%.

Tolerance of measurements of the Luminous Intensity is ±10%

3) 正向电压测量公差为: ±0.1V.

Tolerance of measurements of the Forward Voltage is ±0.1V

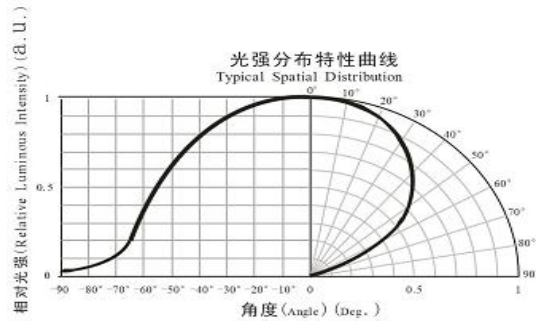
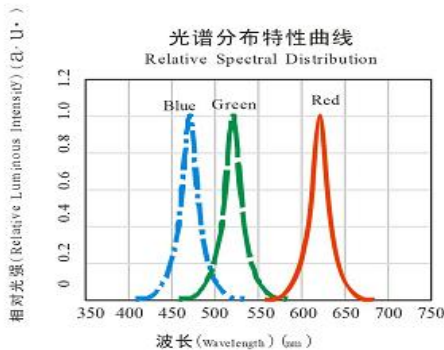
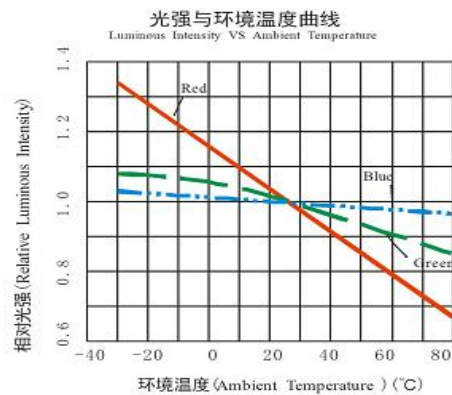
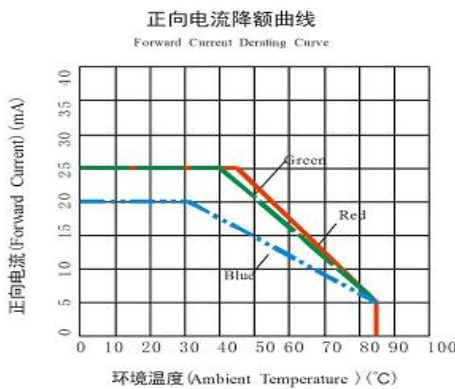
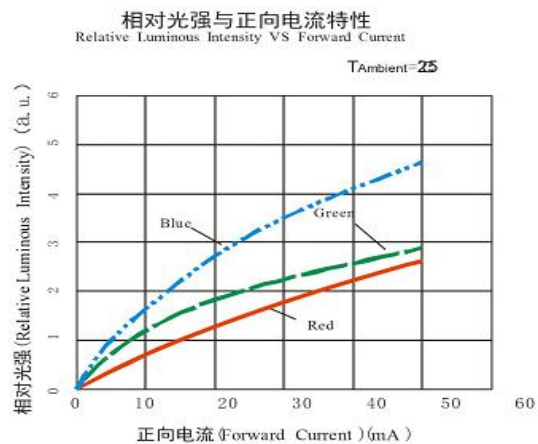
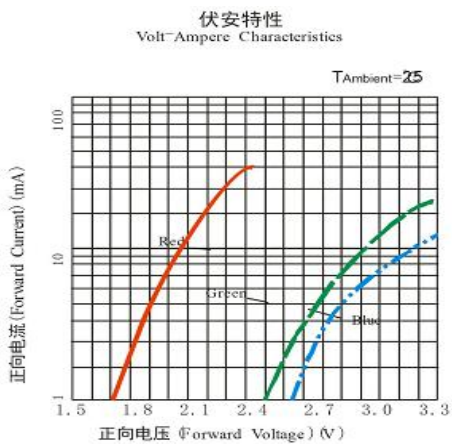
4) 对于如何安全使用请参阅第 10-15 页.

Please refer to page 10 to page 15 for how to use product safely

5) 我们一直在努力提升 LED 产品的性能, 规格如有变更, 恕不另行通知.

We are improving our products always, the technical parameters described in Spec. are subject to change without notice.

典型的光-电曲线图/ Typical Characteristics Curves :

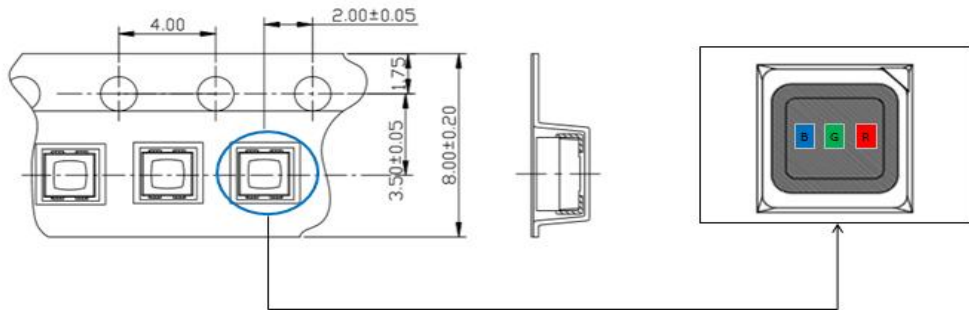


信赖性测试/ Reliability Test Items And Conditions

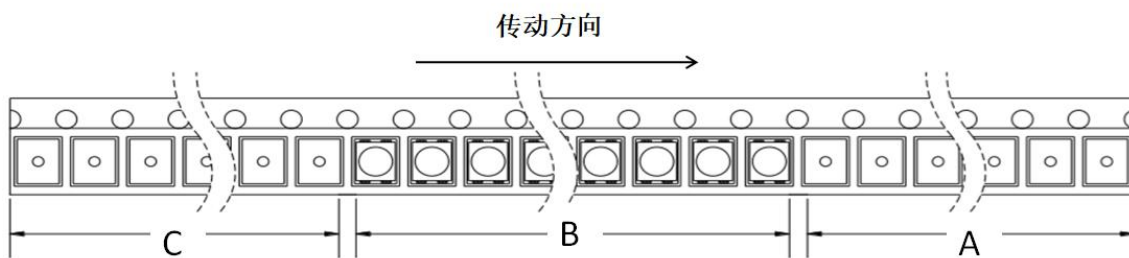
项目 Test Items	参考标准 Reference	实验条件 Test Conditions	时间 Time	样品数 Quantity	判断标准 Criterion
防水实验 Water Proof Test	---	过回流后, 红墨水浸泡 Immersing in red water after reflow	24H	100	0/100
冷热冲击 Thermal Shock	MIL-STD-202G	-55°C (15min)~150°C (15min)	200Cycles	144	0/144
高温高湿储存 High temperature and humidity storage	JEITA-ED-4701 100 103	Ta=85°C RH=85%	1000H	100	0/100
高温储存 High temperature storage	JEITA-ED-4701 200 201	Ta=100°C	1000H	100	0/100
低温储存 Cryogenic storage	JEITA-ED-4701 200 202	Ta=-40°C	1000H	100	0/100
常温寿命 Life Test	---	Ta=25°C IFR=15mA, IFG=8mA, IFB =5mA	1000 H	20	相对初始值 /Relative to Initial Data: Vf±10%; IR≤15μA; Average IV degradation≤30%; Single LED IV degradation≤50%
耐焊接热 Resistance to Soldering Heat	---	Tsol*=255°C 10sec.	2 times	144	0/144

包装/Package:

1. 载带/Tape:



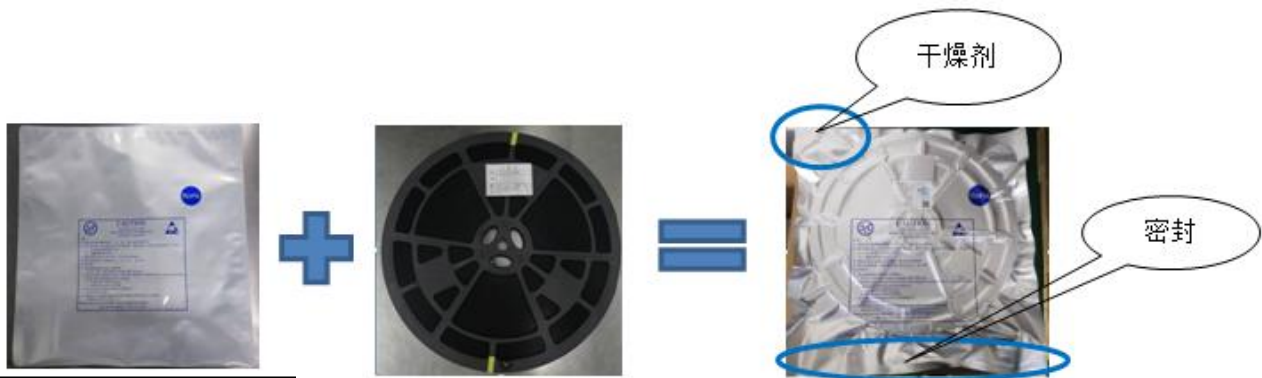
2. 包装-载带装填/Trailer and Leader :



A:前空 (头部) · 400mm B:装料 12000 颗/盘 C:后空(尾部) · 160mm

A: Leader, Empty, 400mm; B:12000 PCS Loaded; C: Trailer, Empty, 160mm.

3. 防静电真空包装/Moisture-Proof & Antistatic Foil Bag Package :

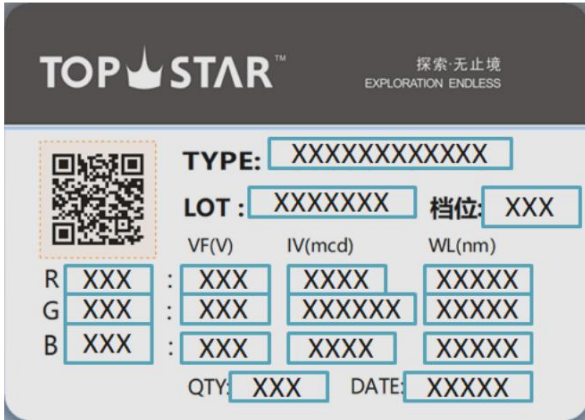


防静电铝箔袋*1
Moisture-Proof &
Antistatic Foil Bag*1

12000/盘 *2
12000 pcs/Reel*2

24000/袋
24000pcs/Bag

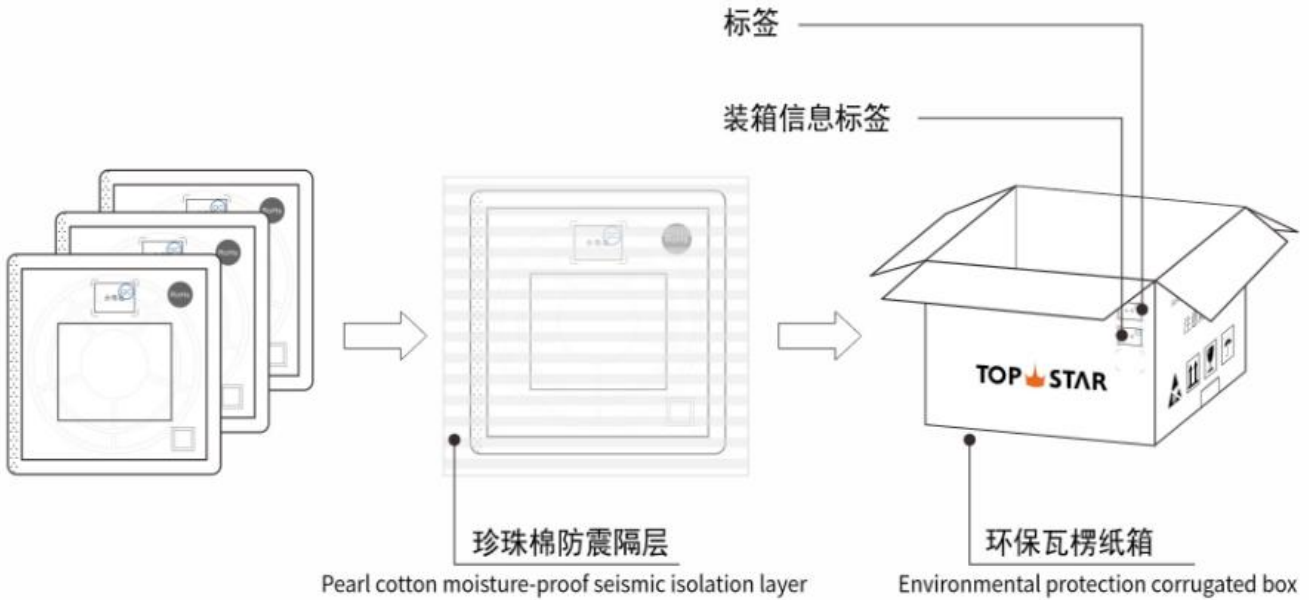
4. 标签说明：



标签说明/Label State:

- ◇ Type: Product Type 产品型号
- ◇ Lot No: Lot Number 产品批号
- ◇ VF: Forward Voltage Range 正向电压范围
- ◇ IV: Luminous Intensity Range 光强范围
- ◇ WL: Wavelength Rang 波长范围
- ◇ QTY: Quantity 数量
- ◇ Date: Production Date 生产日期

5. 外箱包装/Carton Package：

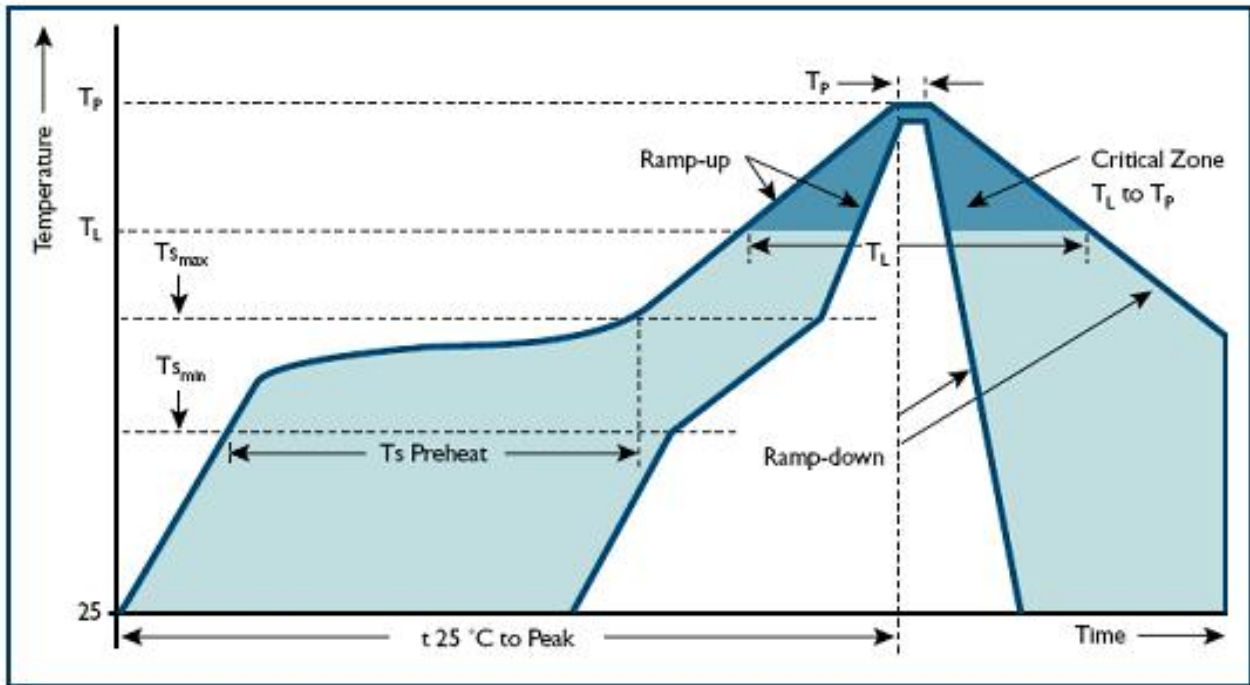


10 袋，20 盘，共 240000pcs/箱
10 Bags, 20Reels, 240000pcs/Carton

焊接建议/Recommended Soldering Condition:

A. 回流焊接：建议按以下温度曲线图进行

Recommended Reflow Soldering Condition



有铅锡/Lead Solder	无铅锡/Lead-free Solder
温度上升斜率 Tsmax to TP= 3°C/s 最大 Temperature rise slope Tsmax to TP= 3°C/s (Max)	温度上升斜率 Tsmax to TP=3°C/s 最大 Temperature rise slope Tsmax to TP=3°C/s (Max)
预热温度 Tsmin= 100°C ~ 150°C Preheating temperature Tsmin= 100°C ~ 150°C	预热温度 Tsmin= 150°C ~ 200°C Preheating temperature Tsmin = 150°C ~ 200°C
预热时间 Tsmin to Tsmax = 100s 最大 Preheating time Tsmin to Tsmax = 100s (Max)	预热时间 Tsmin to Tsmax = 100s 最大 Preheating time Tsmin to Tsmax = 100s (Max)

温度下降斜率为 5°C/s 最大 Temperature down slope 5°C/s (Max)	温度下降斜率为 5°C/s 最大 Temperature down slope 5°C/s (Max)
峰值温度 TP = 220°C 最大 Peak temperature TP = 220°C (Max)	峰值温度 TP = 255°C 最大 Peak temperature TP = 255°C (Max)
在峰值温度±5°C时间不能超过 10s /Time at peak temperature ± 5 °C shall not exceed 10s	在峰值温度±5°C时间不能超过 10 s /Time at peak temperature ± 5 °C shall not exceed 10s
超过 183°C的温度的时间不能超过 80s. The time of temperature exceeding 183 °C shall not exceed 80s.	超过 217°C 的温度的时间不能超过 60s. The time of temperature exceeding 217 °C shall not exceed 60s.

注意/Note :

1. 焊接回流时不能对灯珠施加外力，施加外力会损害灯珠。
Stress on the LEDs should be avoided during heating in the reflow soldering process.
2. 回流焊只能进行一次
Reflow soldering should not be done more than one time.
3. 在焊接之后，要让它自然冷却后才能进行其他作业。
After soldering, do not deal with the product before its temperature drop down to room temperature

B 使用烙铁人手焊接

Recommended Hand Soldering Condition

1.如使用手工焊接，建议使用小于 25 瓦的电烙铁，烙铁温度必须控制在 315°C以下，焊接时间不能超过 2 秒。手工焊接时电烙铁不可触及 SMD LED 表面。

If manual soldering is used, the use of a soldering iron of less than 25W is recommended. The temperature of the iron must be kept below 315°C, with soldering time within 3 seconds and each electrode can be only soldered at one time.

2.烙铁不能接触到支架的 PPA,以及杯内的环氧树脂部分。

The epoxy resin of the SMD LED should not contact the tip of the soldering iron.

3.焊接期间，不可以对器件施加机械压力。

No mechanical stress should be exerted on the resin portion by the tip of the soldering iron.

4.当焊接好之后，要让它冷却下来到温度低于 40°C才可以进行其他作业。

After soldering, do not deal with the product before its temperature drop down to 40 °C

使用注意事项/Precautions for use

1 · 清洁方法/Clean method

不要使用不明化学液体清洗产品：不明的化学液体可能会损坏产品。当必要清洗时，把产品用酒精擦拭，并且自然干燥 15 分钟，然后才开始使用。

Do not use unknown chemical liquid to clean the product: unknown chemical liquid may damage the product. When cleaning is necessary, wipe the product with alcohol and dry it for 15 minutes before use.

2. 防潮湿包装方法/ Moisture proof packaging method:

为避免产品在运输及储存中吸湿,产品的包装是用防潮的铝箔袋包装 并且包装袋里面含有干燥剂，干燥剂主要起到控制包装袋里的湿度。

In order to avoid moisture absorption during transportation and storage, the product is packed in moisture-proof aluminum foil bag, and the bag contains desiccant, which mainly controls the humidity in the bag.

3 · 储存及使用方法 Storage and method of application

SMD LED 产品对潮湿极度敏感。为确保产品回流后保持更长久稳定的品质，请客户按以下要求使用：

SMD LED products are extremely sensitive to humidity. In order to ensure long-term and stable quality after reflow, please use according to the following requirements:

A. 包装袋密封后贮存在条件为温度 5°C-30°C，湿度 < 60%RH，要求所有产品上线前均按要求进行烘烤除湿。

Storage environment: All the products should be stored in the environment of temperature 5°C ~30°C and humidity<60%RH before foiled bags open and need to be baked before SMT.

B. 在开包装之前，请先检查包装袋有无漏气，如果有漏气现象，请重新烘烤使用。

Before using, please check whether there is any air leakage or not, If the bag has leaked air, Please bake the product with below condition.

C. 开封后请在以下条件使用：温度 < 30°C、湿度在 60%RH 以下使用，并于 6h 内完成贴片，如果超过使用时间，须将产品重新烘烤使用。

产品烘烤时参照以下烘烤条件：

2 个月以内 (未受潮): (70±5) °C×12h

2 个月以外 (未受潮): (70±5) °C×24h

如果确认灯珠已受潮，或包装袋破损漏气，或包装时间超过 6 个月： (70 ± 5) °C×48h

Before soldering ,the product must be stored under the condition of $<30^{\circ}\text{C}$ and $<60\%RH$. Under these conditions the SMD LEDs must be used (subject to reflow oven) within 6 hours.

Baking condition :

Within 2 months (undamped) : (70 ± 5) °C×12h

After 2 months (undamped): (70 ± 5) °C×24h

Damped/Foiled bag leakage/ beyond 6 months' storage at customers' side: (70 ± 5) °C×48h

4 · 静电/Static Electricity

A. 静电和电涌会导致产品特性发生改变，例如正向电压降低等，如果情况严重甚至会损毁产品。
所以在使 用时必须采取有效的防静电措施。

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs can not be lighted up. In view of the above, we should do some anti-static precautions when using the SMD LEDs.

B.使用防静电之手环/垫子/工作服/工作鞋/手套/防静电容器，可以用来防止静电

It is also recommended that anti-electrostatic wrist bands, pads, uniforms, gloves or containers can be used when dealing with the LEDs.

C. 所有相关的设备和机器都应该正确接地，同时必须采取其他防止静电的措施。

All devices, equipments and machineries must be properly grounded, at the same time we should take measures to prevent anti-static and voltage surge.

5 · 温度保护： The safe temperature for LEDs working

LED 在高温条件下，衰减会加速，本身应力也会增大，若长期处于高温环境下，极容易出现失效。

对于高密度排列使用的情况，建议在使用过程中灯面温度不超过 50°C，灯脚温度不超过 70°C。

The high temperature will make the LEDs' Luminous Intensity decreased radically, if LEDs are used in hot environment for a long time, they will be disabled easily. When LEDs are used in a high density array, we suggest that the LEDs' surface temperature should be lower than 50°C and the legs' temperature should be lower than 70°C.

6.反向电压控制/ Reverse voltage Control

如果 LED 长期遭受超过其所能承受的反向电压冲击时，LED 会被损伤，反向漏电流会变大。这样会引起显示屏零灰度下串光的发生。在设计中，要注意控制反向电压，建议加在 LED 上的反向电压值不超过 5V

When LED is often suffered the reverse voltage which exceeds the limit of the component then it will be damaged. Such as the reverse current increase rapidly. And it will cause the string light when the screen is black. So please pay attention to controlling the reverse voltage which less than 5V is recommended.